

CABLINE®-CAL IIF

Part No. Plug: 21088-050T-01
Receptacle: 21089-050E-01

Product Specification

Qualification Test Report No. TR-24059

0	S24457	November 8, 2024	R.Hatano	T.Tanigawa	H.Ikari
Rev.	ECN	Date	Prepared by	Checked by	Approved by

1. Scope

This product specification defines the test conditions and the performances of the CABLINE-CAL IIF Connector, FPC-to-board connector of 0.4mm contact pitch.

2. Product Name and Parts No.

2.1 Product Name

CABLINE-CAL IIF

2.2 Parts No.

Plug: 21088-050T-01

Receptacle: 21089-050E-01

2.3 Applicable FPC

Shielded FPC Conductor pitch / size of thickness . . . 0.4mm / 0.25+0.02/-0.03mm

Thermosetting adhesive. Refer to the product drawing (DWG No.21088) for a detail dimension and structure.

3. Rating

3.1 Operating Conditions

Amperage: 0.26A AC/DC (per contact)

Voltage: 100V AC (per contact)

Operating temperature: 233~358K(-40°C~+85°C) (Containing temperature rise by current)

Operating humidity: 85% max

3.2 Storage Conditions

Storage temperature: 248~333K(-25°C~+60°C)

Storage humidity: 85% max. (Non-condensing)

4. Test and Performance

Test Condition

Unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

Temperature: 288K~308K (15°C~35°C)

Pressure: 866hPa~1066hPa (650mmHg~800mmHg)

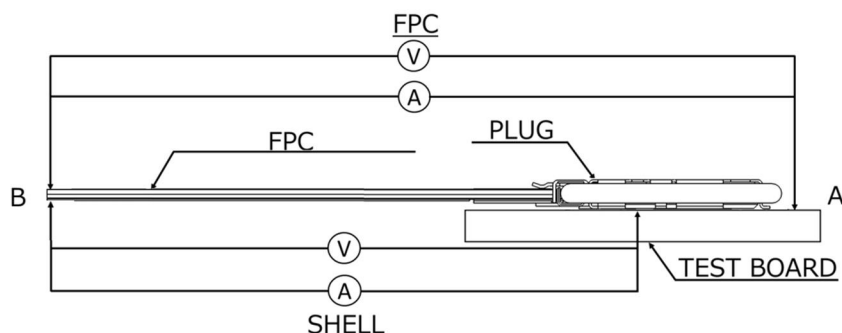
Relative humidity: 45~75%R.H.

4.1 Electrical Performance

1. Contact resistance

Reference standard: MIL-STD-202-307

Test conditions: Solder the receptacle connector to the test board and mate the plug connector together, then apply 20mV MAX. DC open circuit voltage and 10mA MAX. DC closed circuit current. Measure the contact resistance of signal and GROUND(SHELL) at the section shown in Fig.1 by the four terminal methods.



$$\text{Contact Resistance} = R_{AB} - (\text{FPC Conductor Resistance}) - (\text{Test Board Conductor Resistance})$$

Fig.1

Pass criteria: Signal Contact: Initial: 100 mΩ MAX. After testing: ΔR 40 mΩ MAX.
Ground Shell: Initial: 100 mΩ MAX. After testing: ΔR 40 mΩ MAX.

2. Insulation resistance

Reference standard: MIL-STD-202-302

Test conditions: Solder the receptacle connector to the test board and mate the plug connector together, then apply DC 250 V between the neighboring contacts and between contacts and shell.

Pass criteria: Initial: 1000 MΩ MIN. After testing: 500 MΩ MIN.

3. Dielectric withstanding voltage

Reference standard: MIL-STD-202-301

Test conditions: Solder the receptacle connector to the test board and mate the plug connector together, then apply AC 250V(rms) between the neighboring contacts and between contacts and shell for a minute.

Pass criteria: No creeping discharge, flashover, no insulator breakdown shall occur.

4. Temperature rising

Reference standard: -

Test conditions: Solder the receptacle connector to the test board and mate the plug connector together, and apply rating current per contact. Measure delta T over ambient.

Pass criteria: Over ambient ΔT 30 °C MAX.

4.2 Mechanical Performance

1. Mating force and Un-mating force		
Reference standard:	-	
Test conditions:	Solder the receptacle connector to the test board, then place the board and plug on push-on/pull-off machine. Repeat mating/unmating 30 cycles at a speed 25 ± 3 mm/min. along the mating axis. Measure the mating and unmating force at the initial and after 30cycles.	
Pass criteria:	Mating force: (Initial/After 30cycles) 50P: 15.00 N MAX.	Unmating force: (Initial/After 30cycles) 50P: 1.00 N MIN.

2. Durability		
Reference standard:	-	
Test conditions:	Solder the receptacle connector to the test board, then place the board and plug on the push-on/pull-off machine, and repeat mating and unmating 30cycles at a speed 25 ± 3 mm/min. along the mating axis.	
Pass criteria:	Contact resistance: Shall meet 4.1.1	

3. Contact Retention Force		
Reference Standard:	-	
Test Conditions:	Place the connector on the push-on/pull-off machine, then apply force on the contact head and push the contact along the direction opposite to the contact insertion at a speed of 25 ± 3 mm/min. Measure the force when the contact dislodges the connector.	
Pass Criteria:	Receptacle Contact Retention Force: 0.2N MIN.	

4. Connector Lock		
Reference standard:	-	
Test conditions:	Solder the receptacle connector to the test board and mate the plug connector together, and place them on the push-on/pull-off machine, then pull the FPC until 10N along the mating axis at a speed 25 ± 3 mm/min.	
Pass criteria:	It shall not occur the damage and unlock.	

5. Vibration		
Reference standard:	MIL-STD-202-201	
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and place them on the vibrator. Then apply the following vibration. During the testing, run 100mA DC to check electrical discontinuity. Frequency: 10Hz→55Hz→10Hz/approx. 1min. Directions: 3 mutually perpendicular direction. Total Amplitude: 1.52mm Sweep duration: 2 hours for each direction, a total of 6 hours.	
Pass criteria:	Contact resistance: Shall meet 4.1.1. Electrical discontinuity: No electrical discontinuity greater than $1\mu s$ shall occur. Appearance: No abnormality adversely affecting the performance shall occur.	

4.2 Mechanical Performance

6. Shock	
Reference standard:	MIL-STD-202-213, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and place them on the shock machine. Then apply the following shock. MAX.G: 50G Duration: 11msec Wave Form: Half Sinusoidal Directions: 6 mutually perpendicular direction Cycle: 3 cycles about each direction
Pass criteria:	Contact resistance: Shall meet 4.1.1. Electrical discontinuity: No electrical discontinuity greater than 1 μ s shall occur. Appearance: No abnormality adversely affecting the performance shall occur.

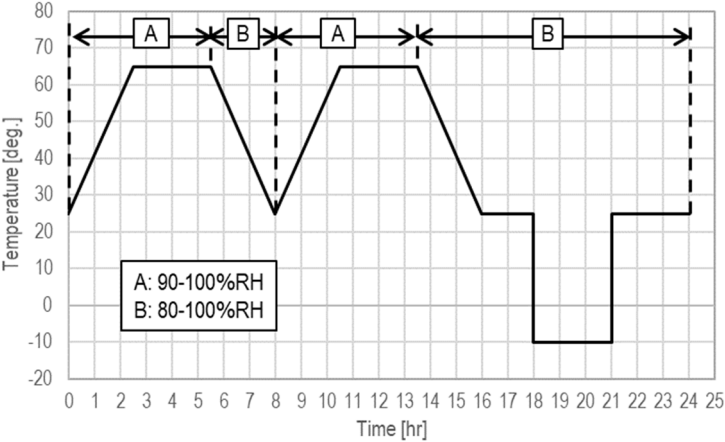
4.3 Environmental Performance

1. Thermal shock	
Reference standard:	MIL-STD-202-107, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 218K(-55°C),30min.→358K(85°C),30min. Transition time: 5min. MAX. Cycle: 5 cycles
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

2. High temperature life	
Reference standard:	MIL-STD-202-108, Condition B.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 358 \pm 2K (85 \pm 2°C) Duration: 250 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

3. Humidity (Steady state)	
Reference standard:	MIL-STD-202-103, Condition A.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 313 \pm 2K (40 \pm 2°C) Humidity: 90~95%RH Duration: 240 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur.

4.3 Environmental Performance

4. Humidity (Cycling)	
Reference standard:	MIL-STD-202-106.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 298[263]~338K (25[-10]~65℃) Humidity: 90~98%RH Duration: 10cycles (240hours)
 <p>The graph shows Temperature [deg.] on the y-axis (ranging from -20 to 80) and Time [hr] on the x-axis (ranging from 0 to 25). The profile consists of several segments: a ramp up from 25°C to 65°C (0-3 hr), a dwell at 65°C (3-5 hr), a ramp down to 25°C (5-8 hr), a dwell at 25°C (8-9 hr), a ramp up to 65°C (9-11 hr), a dwell at 65°C (11-13 hr), a ramp down to 25°C (13-16 hr), a dwell at 25°C (16-18 hr), a ramp down to -10°C (18-20 hr), a dwell at -10°C (20-21 hr), a ramp up to 25°C (21-22 hr), and a dwell at 25°C (22-24 hr). Segments A (90-100%RH) are indicated above the 65°C dwell periods (3-5 hr and 11-13 hr). Segments B (80-100%RH) are indicated above the 25°C dwell periods (8-9 hr and 22-24 hr).</p>	
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur.

5. Salt water spray	
Reference standard:	MIL-STD-202-101, Condition B.
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 308±2K (35±2℃) Salt water density: 5±1% [by weight] Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

6. H ₂ S gas	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board, then mate plug connector, and expose them to the following environment. Temperature: 313±2K (40±2℃) Relative humidity: 80±5%RH Gas: H ₂ S 3±1ppm Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Appearance: No abnormality adversely affecting the performance shall occur.

4.4. Others

1. Solderability	
Reference Standard:	-
Test Conditions:	Immerse the contact soldering part to flux of RMA or R type for 5 to 10 seconds, then dip the part into the solder bath of 518±5K (245±5 °C) for 5±0.5 seconds.
Pass Criteria:	More than 95% of the dipped surface shall be evenly wet.

2. Resistance to Soldering Heat	
Reference Standard:	-
Test Conditions:	Reflow Temperature: See Fig.2. Cycle: 2
<div><div><div>IRリフロー条件 (IR Reflow Condition)</div><div>・リフロー部 (Reflow Part)</div><div>ピーク (Peak): 260°C</div><div>255°C: 30s</div><div>217°C: 60~150s</div><div>・予熱部 (Pre-heat part)</div><div>150~200°C: 60~120s</div></div><div><p>The graph shows a temperature profile over time. The y-axis is labeled 'Temperature' and the x-axis is labeled 'Time'. The profile starts at 25°C, rises linearly at 3°C/s MAX to 150°C, then continues to rise linearly at 3°C/s MAX to 200°C. It then rises linearly at 6°C/s MAX to a peak of 260°C MAX. It remains at the peak for 30s, then falls linearly at 6°C/s MAX to 217°C (60~150s), then continues to fall linearly at 6°C/s MAX to 150°C, and finally falls linearly at 6°C/s MAX back to 25°C. A horizontal dashed line at 25°C spans the entire duration, with a label 'Time 25°C to Peak 8minutes. MAX.' below it. A horizontal double-headed arrow between the 150°C and 200°C levels is labeled '60~120s'.</p></div></div>	
Fig.2	
Pass Criteria:	No deformation nor defect adversely affecting the performance occur.

4.4 Test Sequence and Specimen Quantity

Details of the Testing Groups A to K are indicated in test report.

Table.1 Test Sequence and Sample Quantity

No.		Test Item	Testing Groups												
			A	B	C	D	E	F	G	H	J	K	L	M	N
4.1 Electrical Performance	1	Contact resistance		2,6			1,3,5	1,3	1,3	1,5	1,5	1,3	1,3		
	2	Insulation resistance								2,6	2,6				
	3	Dielectric withstanding voltage								3,7	3,7				
	4	Temperature rising	1												
4.2 Mechanical Performance	1	Mating force		1,5											
		Unmating force		3,7											
	2	Durability		4											
	3	Connector retention force			1										
	4	Connector lock				1									
	5	Vibration					2								
	6	Shock					4								
4.3 Environmental Performance	1	Thermal shock						2							
	2	High temperature life							2						
	3	Humidity (Steady State)								4					
	4	Humidity (Cycling)									4				
	5	Saltwater spray										2			
	6	H ₂ S gas											2		
4.4 Others	1	Solder ability												1	
	2	Soldering heat resistance													1
Specimen quantity			5 pcs	5 pcs	5 pcs	5 pcs	5 pcs	5 pcs	5 pcs	5 pcs	5 pcs	5 pcs	5 pcs	10 pcs	10 pcs

※Numbers indicate test sequences.

5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension.

5. Precautions for Handling Cable Connectors

Refer to instruction manual : HIM-24027 for the handling of CABLINE-CAL IIF.